

SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

SDLS074 - DECEMBER 1972 - REVISED MARCH 1988

- Cascading Circuitry Provided Internally
- Synchronous Operation
- Individual Preset to Each Flip-Flop
- Fully Independent Clear Input

TYPES	TYPICAL MAXIMUM COUNT FREQUENCY	TYPICAL POWER DISSIPATION
'192, '193	32 MHz	325 mW
'LS192, 'LS193	32 MHz	95 mW

description

These monolithic circuits are synchronous reversible (up/down) counters having a complexity of 55 equivalent gates. The '192 and 'LS192 circuits are BCD counters and the '193 and 'LS193 are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincidentally with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes which are normally associated with asynchronous (ripple-clock) counters.

The outputs of the four master-slave flip-flops are triggered by a low-to-high-level transition of either count (clock) input. The direction of counting is determined by which count input is pulsed while the other count input is high.

All four counters are fully programmable; that is, each output may be preset to either level by entering the desired data at the data inputs while the load input is low. The output will change to agree with the data inputs independently of the count pulses. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

A clear input has been provided which forces all outputs to the low level when a high level is applied. The clear function is independent of the count and load inputs. The clear, count, and load inputs are buffered to lower the drive requirements. This reduces the number of clock drivers, etc., required for long words.

These counters were designed to be cascaded without the need for external circuitry. Both borrow and carry outputs are available to cascade both the up- and down-counting functions. The borrow output produces a pulse equal in width to the count-down input when the counter underflows. Similarly, the carry output produces a pulse equal in width to the count-up input when an overflow condition exists. The counters can then be easily cascaded by feeding the borrow and carry outputs to the count-down and count-up inputs respectively of the succeeding counter.

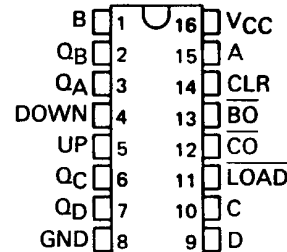
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	SN54'	SN54LS'	SN74'	SN74LS'	UNIT
Supply voltage, V_{CC} (see Note 1)	7	7	7	7	V
Input voltage	5.5	7	5.5	7	V
Operating free-air temperature range	-55 to 125		0 to 70		°C
Storage temperature range	-65 to 150		-65 to 150		°C

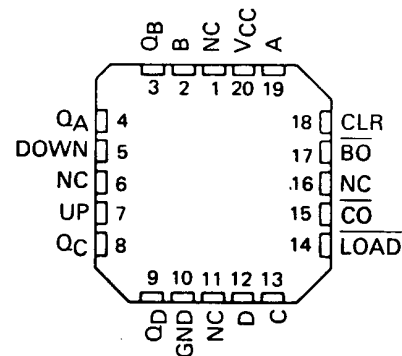
NOTE 1: Voltage values are with respect to network ground terminal.

SN54192, SN54193, SN54LS192,
SN54LS193 . . . J OR W PACKAGE
SN74192, SN74193 . . . N PACKAGE
SN74LS192, SN74LS193 . . . D OR N PACKAGE

(TOP VIEW)



SN54LS192, SN54LS193 . . . FK PACKAGE
(TOP VIEW)

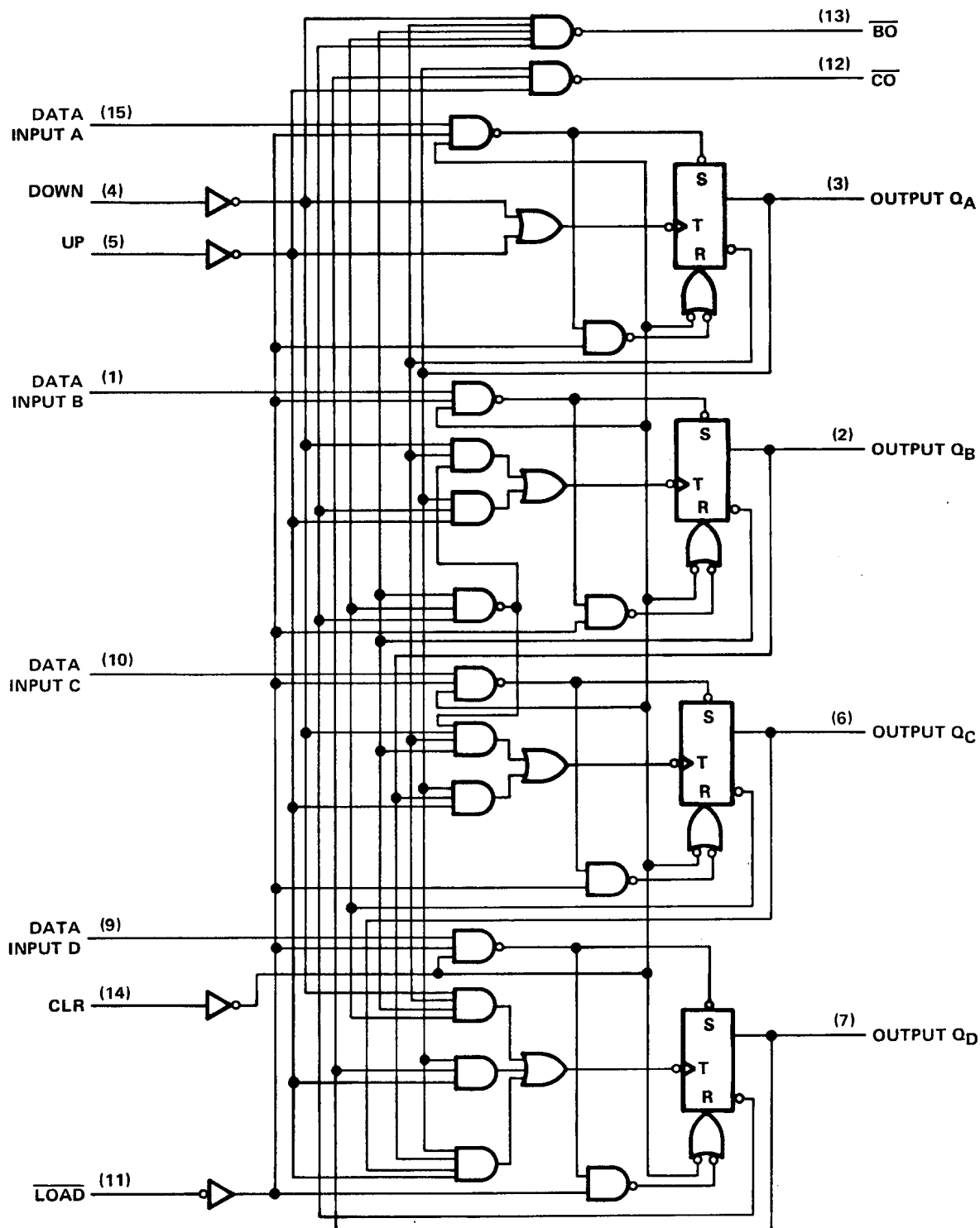


NC - No internal connection

SN54192, SN54LS192, SN74192, SN74LS192

SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

logic diagram (positive logic)



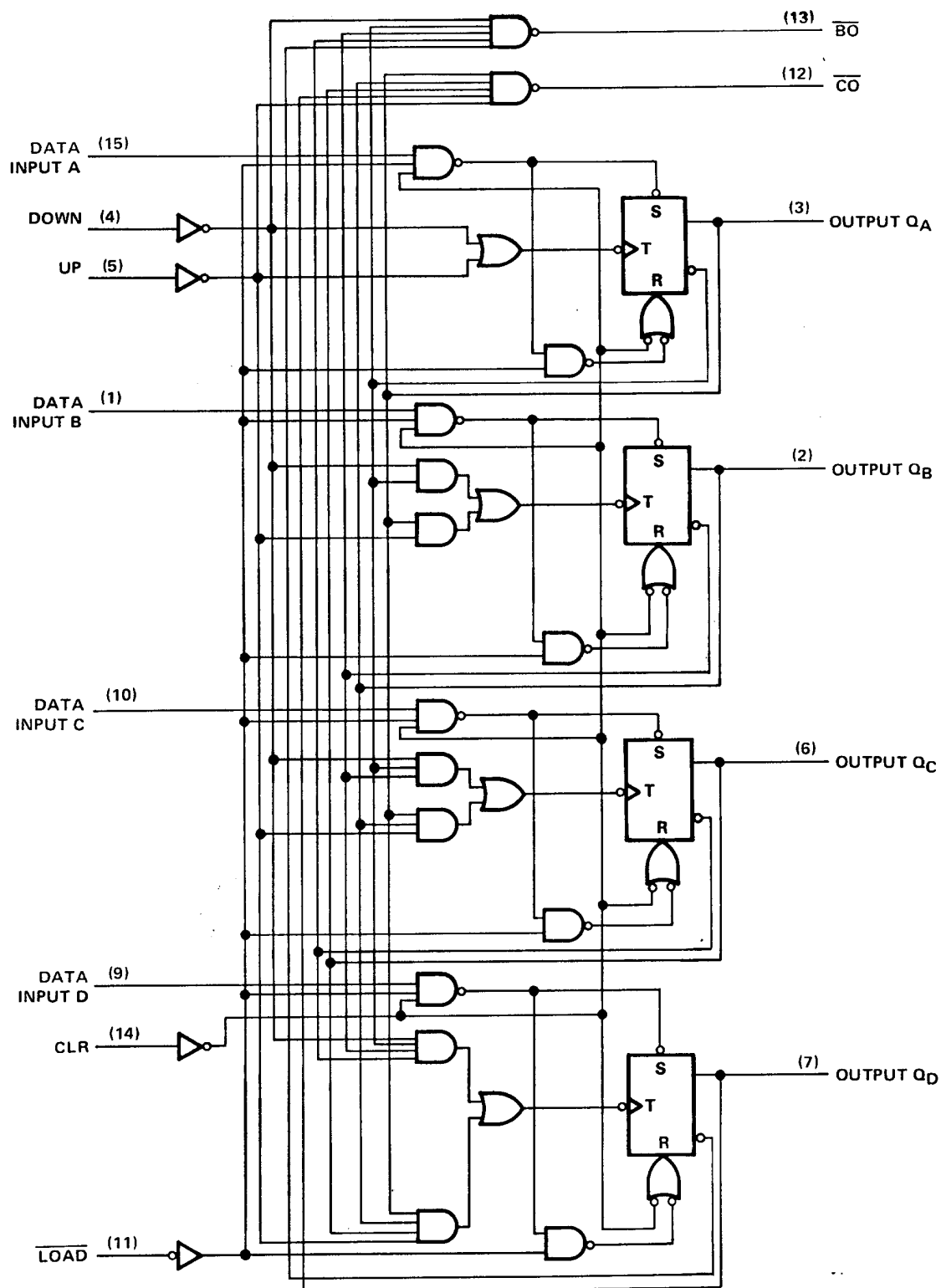
Pin numbers shown are for D, J, N, and W packages.

SN54193, SN54LS193, SN74193, SN74LS193

SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

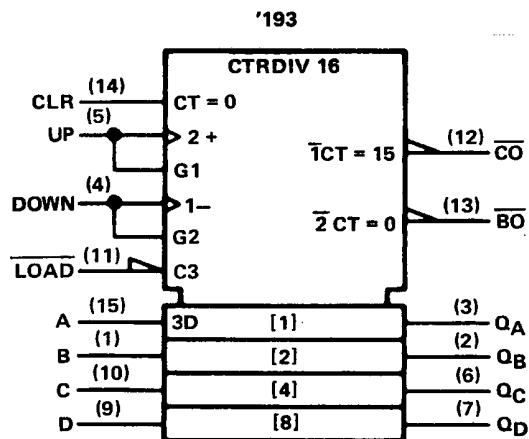
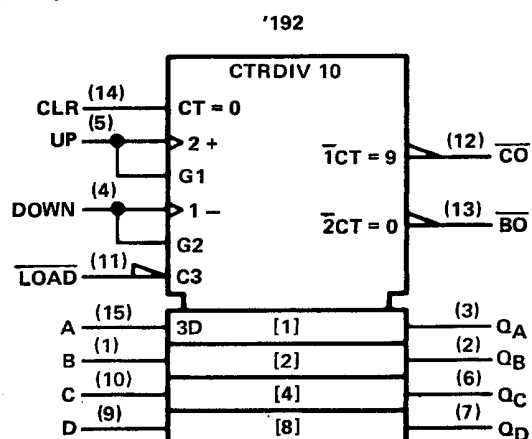


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**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)**

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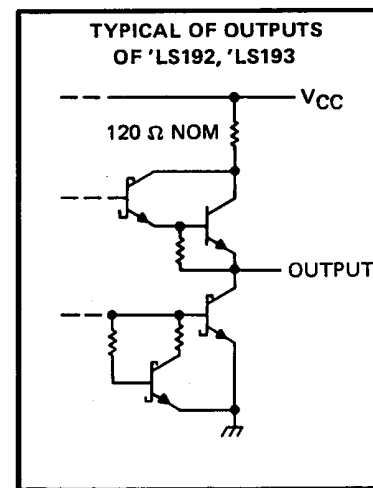
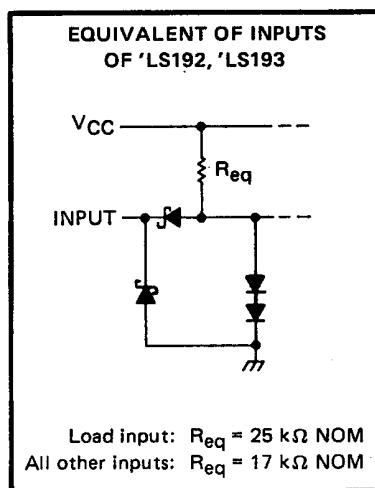
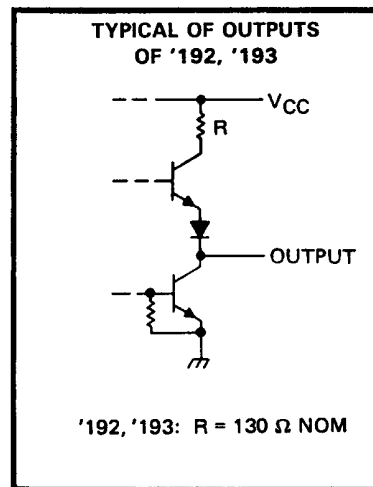
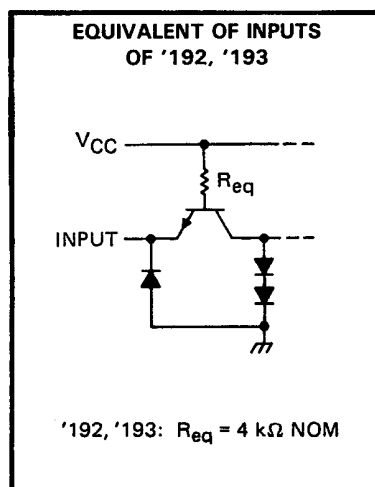
logic symbols†



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



SN54192, SN54LS192, SN74192, SN74LS192 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

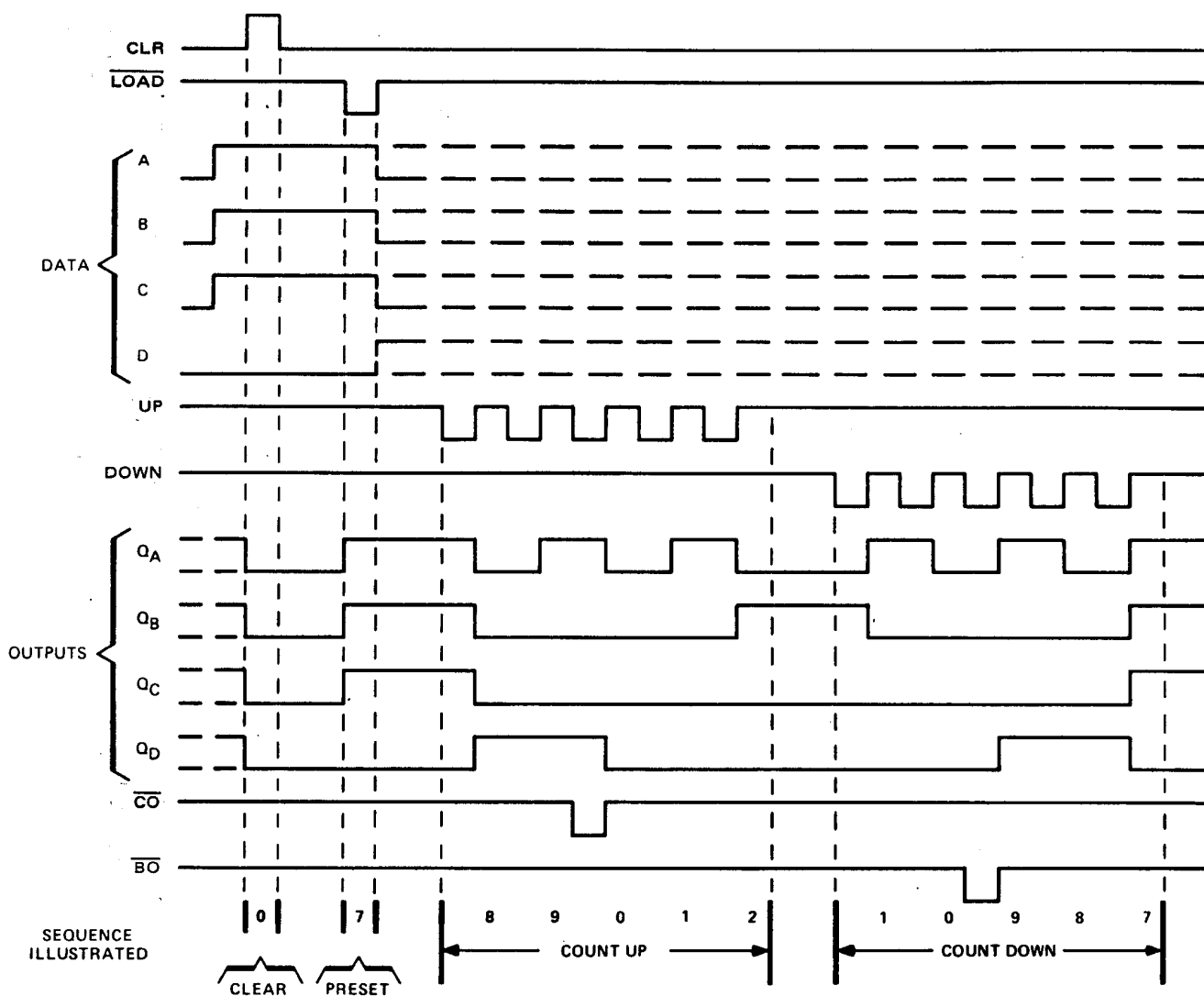
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'192, 'LS192 DECADE COUNTERS

typical clear, load, and count sequences

Illustrated below is the following sequence:

1. Clear outputs to zero.
2. Load (preset) to BCD seven.
3. Count up to eight, nine, carry, zero, one, and two.
4. Count down to one, zero, borrow, nine, eight, and seven.



NOTES: A. Clear overrides load, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



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SN54193, SN54LS193, SN74193, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

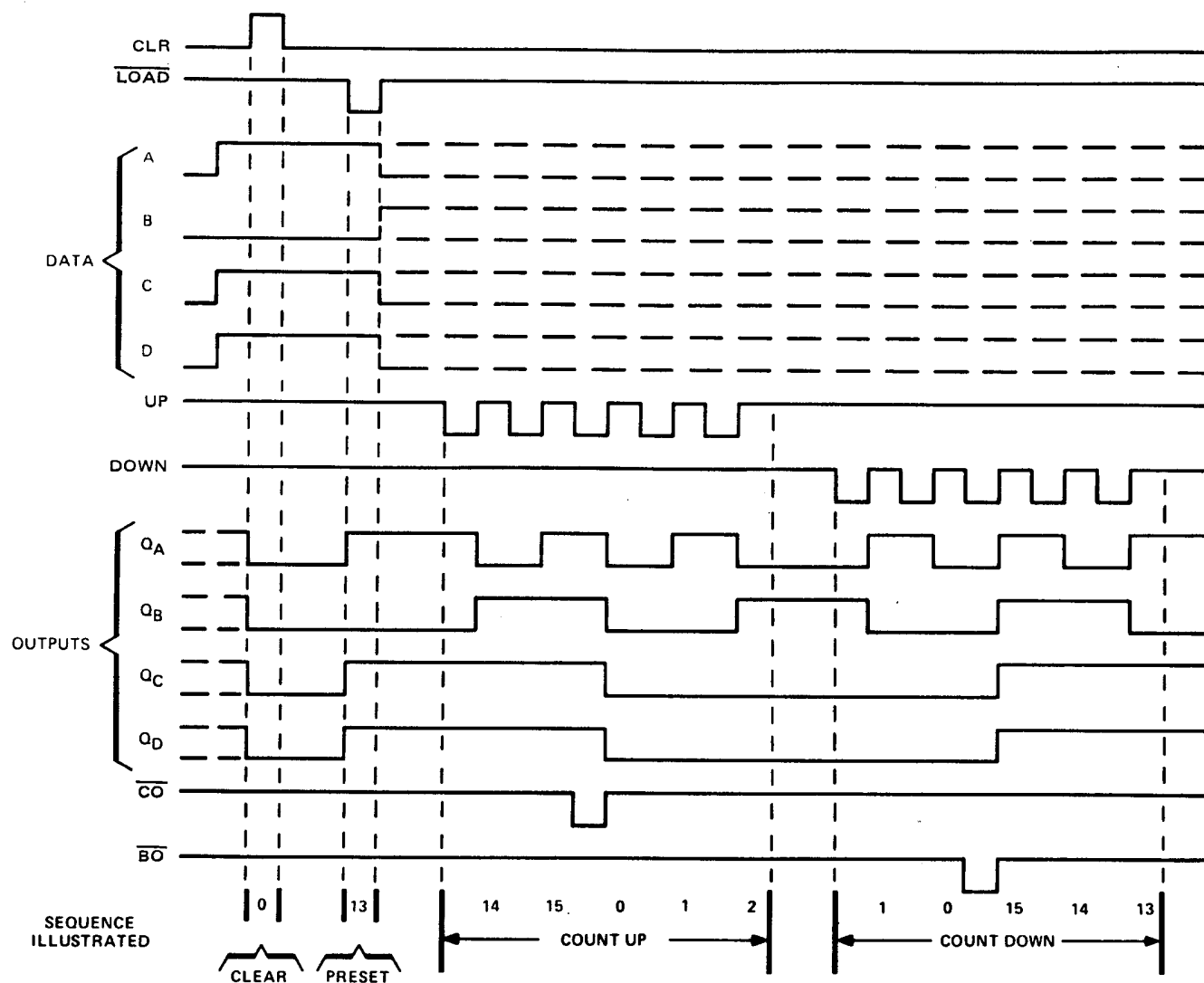
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'193, 'LS193 BINARY COUNTERS

typical clear, load, and count sequences

Illustrated below is the following sequence:

1. Clear outputs to zero.
2. Load (preset) to binary thirteen.
3. Count up to fourteen, fifteen, carry, zero, one, and two.
4. Count down to one, zero, borrow, fifteen, fourteen, and thirteen.



NOTES: A. Clear overrides load, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



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SN54192, SN54193, SN74192, SN74193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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recommended operating conditions

			SN54192 SN54193			SN74192 SN74193			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
I _{OH}	High-level output current		−0.4			−0.4			mA
I _{OL}	Low-level output current		16			16			mA
f _{clock}	Clock frequency		0	25		0	25		MHz
t _w	Width of any input pulse		20			20			ns
t _{su}	Data setup time, (see Figure 1)		20			20			ns
t _h	Hold time	Data, high or low	0			0			ns
		LOAD	3			3			
T _A	Operating free-air temperature		−55 125			0 70			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54192 SN54193			SN74192 SN74193			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
V _{IK}	Input clamp voltage	V _{CC} = MIN, I _I = −12 mA			−1.5			V
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = −0.4 mA			2.4	3.4		V
V _{OL}	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA				0.2	0.4	V
I _I	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V					1	mA
I _{IH}	High-level input current	V _{CC} = MAX, V _I = 2.4 V					40	μA
I _{IL}	Low-level input current	V _{CC} = MAX, V _I = 0.4 V					−1.6	mA
I _{OS}	Short-circuit output current§	V _{CC} = MAX			−20		−65	mA
I _{CC}	Supply current	V _{CC} = MAX, See Note 2				65	89	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER ¶	FROM INPUT	TO OUTPUT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}			C _L = 15 pF, R _L = 400 Ω, See Figures 1 and 2	25	32		MHz
t _{PLH}	UP	$\overline{CO}$			17	26	ns
t _{PHL}					16	24	
t _{PLH}	DOWN	$\overline{BO}$			16	24	ns
t _{PHL}					16	24	
t _{PLH}	UP OR DOWN	Q			25	38	ns
t _{PHL}					31	47	
t _{PLH}	$\overline{LOAD}$	Q			27	40	ns
t _{PHL}					29	40	
t _{PHL}	CLR	Q			22	35	ns

¶ f_{max} ≡ maximum clock frequency

t_{PLH} ≡ propagation delay time, low-to-high-level output

t_{PHL} ≡ propagation delay time, high-to-low-level output



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SN54LS192, SN54LS193, SN74LS192, SN74LS193

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recommended operating conditions

		SN54LS192 SN54LS193			SN74LS192 SN74LS193			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			-400			-400	μ A
I_{OL}	Low-level output current			4			8	mA
f_{clock}	Clock frequency	0		25	0		25	MHz
t_w	Width of any input pulse	20			20			ns
t_{su}	Clear inactive-state setup time	15			15			ns
	Load inactive-state setup time	15			15			ns
	Data setup time (see Figure 1)	20			20			ns
t_h	Data hold time	5			5			ns
T_A	Operating free-air temperature range	-55		125	0		70	$^{\circ}$ C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54LS192 SN54LS193			SN74LS192 SN74LS193			UNIT	
		MIN	TYP‡	MAX	MIN	TYP‡	MAX		
V _{IH} High-level input voltage		2			2			V	
V _{IL} Low-level input voltage		0.7			0.8			V	
V _{IK} Input clamp voltage	V _{CC} = MIN, I _I = −18 mA	−1.5			−1.5			V	
V _{OH} High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = V _{IL} max, I _{OH} = −400 μA	2.5	3.4		2.7	3.4		V	
V _{OL} Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = V _{IL} max			I _{OL} = 4 mA	0.25	0.4	0.15	0.4	V
				I _{OL} = 8 mA			0.35	0.5	
I _I Input current at maximum input voltage	V _{CC} = MAX, V _I = 7 V	0.1			0.1			mA	
I _{IH} High-level input current	V _{CC} = MAX, V _I = 2.7 V	20			20			μA	
I _{IL} Low-level input current	V _{CC} = MAX, V _I = 0.4 V	−0.4			−0.4			mA	
I _{OS} Short-circuit output current§	V _{CC} = MAX	−20	−100		−20	−100		mA	
I _{CC} Supply current	V _{CC} = MAX, See Note 2	19	34		19	34		mA	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: I_{CC} is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

PARAMETER	FROM INPUT	TO OUTPUT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			$C_L = 15 \text{ pF},$ $R_L = 2 \text{ k}\Omega,$ See Figures 1 and 2	25	32		MHz
t_{PLH}	UP	$\overline{CO}$			17	26	ns
t_{PHL}					18	24	
t_{PLH}	DOWN	$\overline{BO}$			16	24	ns
t_{PHL}					15	24	
t_{PLH}	UP OR DOWN	Q			27	38	ns
t_{PHL}					30	47	
t_{PLH}	$\overline{LOAD}$	Q			24	40	ns
t_{PHL}					25	40	
t_{PHI}	CLR	Q			23	35	ns

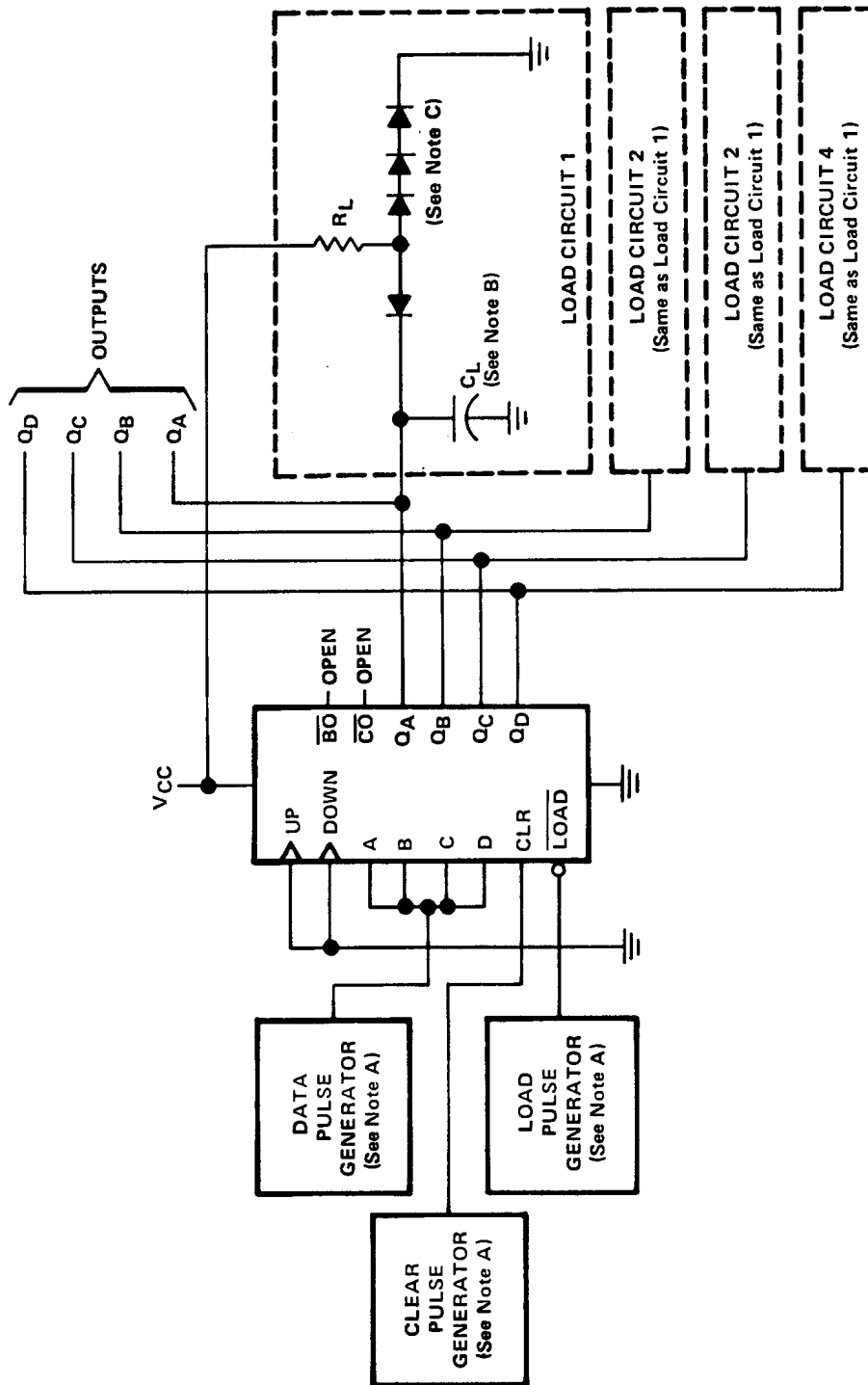


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SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

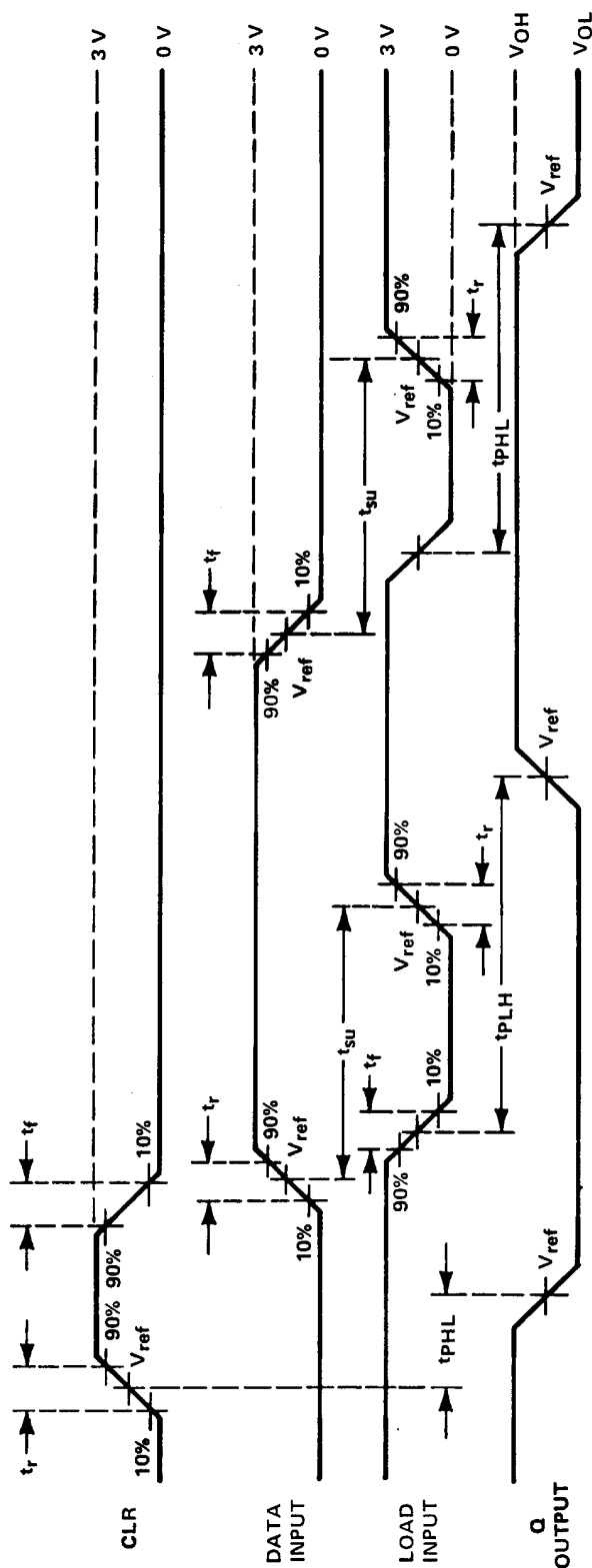
- NOTES: A. The pulse generators have the following characteristics: $Z_{out} \approx 50 \Omega$ and for the data pulse generator PRR ≤ 500 kHz, duty cycle = 50%; for the load pulse generator PRR is two times data PRR, duty cycle = 50%.
- B. C_L includes probe and jig capacitance.
- C. Diodes are 1N3064 or equivalent.
- D. t_r and $t_f \leq 7$ ns.
- E. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 1A - CLEAR, SETUP AND LOAD TIMES

SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

- NOTES: A. The pulse generators have the following characteristics: $Z_{out} \approx 50 \Omega$ and for the data pulse generator PRR ≤ 500 kHz, duty cycle = 50%; for the load pulse generator PRR is two times data PRR, duty cycle = 50%.
- B. C_L includes probe and jig capacitance.
- C. Diodes are 1N3064 or equivalent.
- D. t_r and $t_f \leq 7$ ns.
- E. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

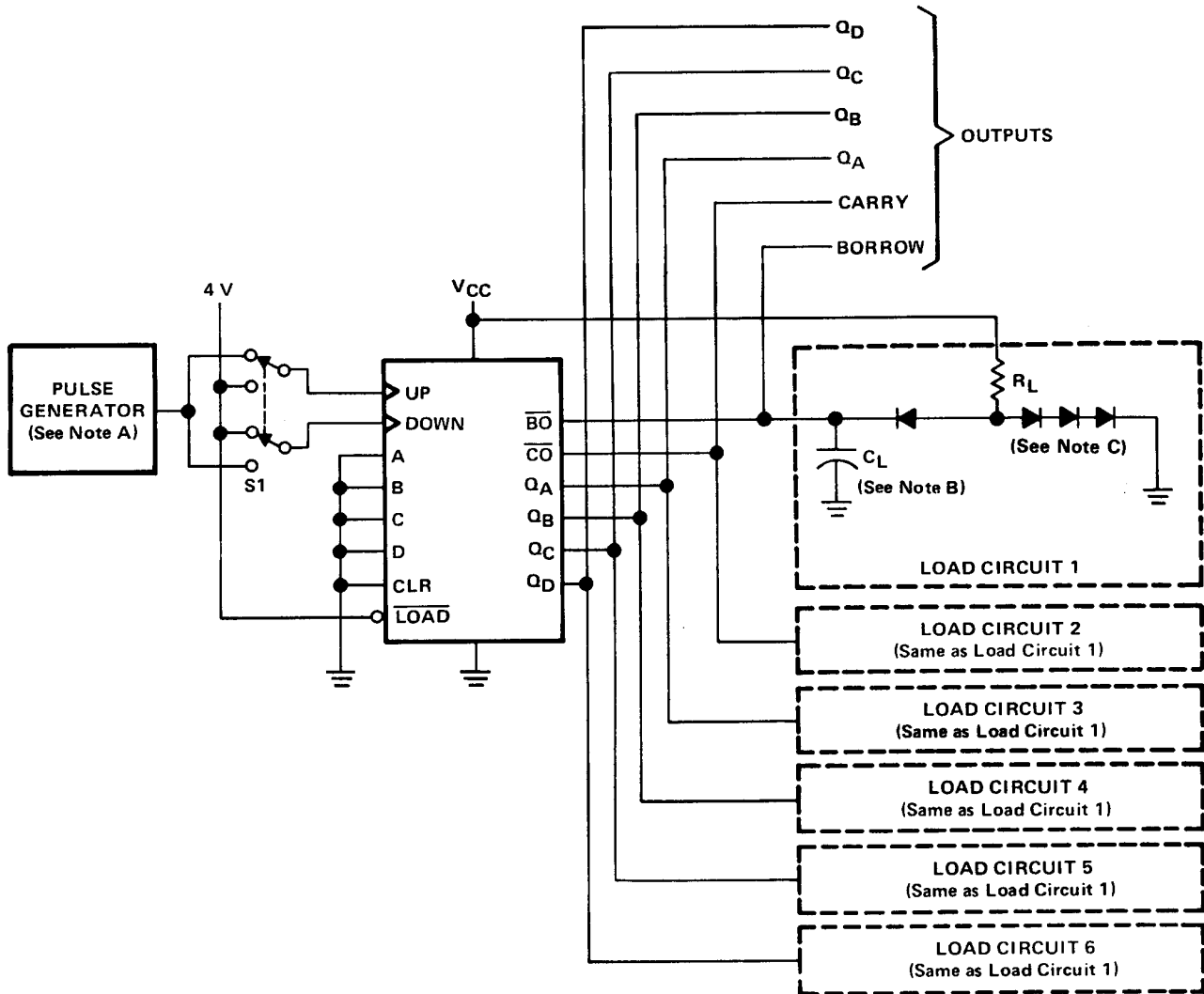
FIGURE 1B - CLEAR, SETUP, AND LOAD TIMES

SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193

SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

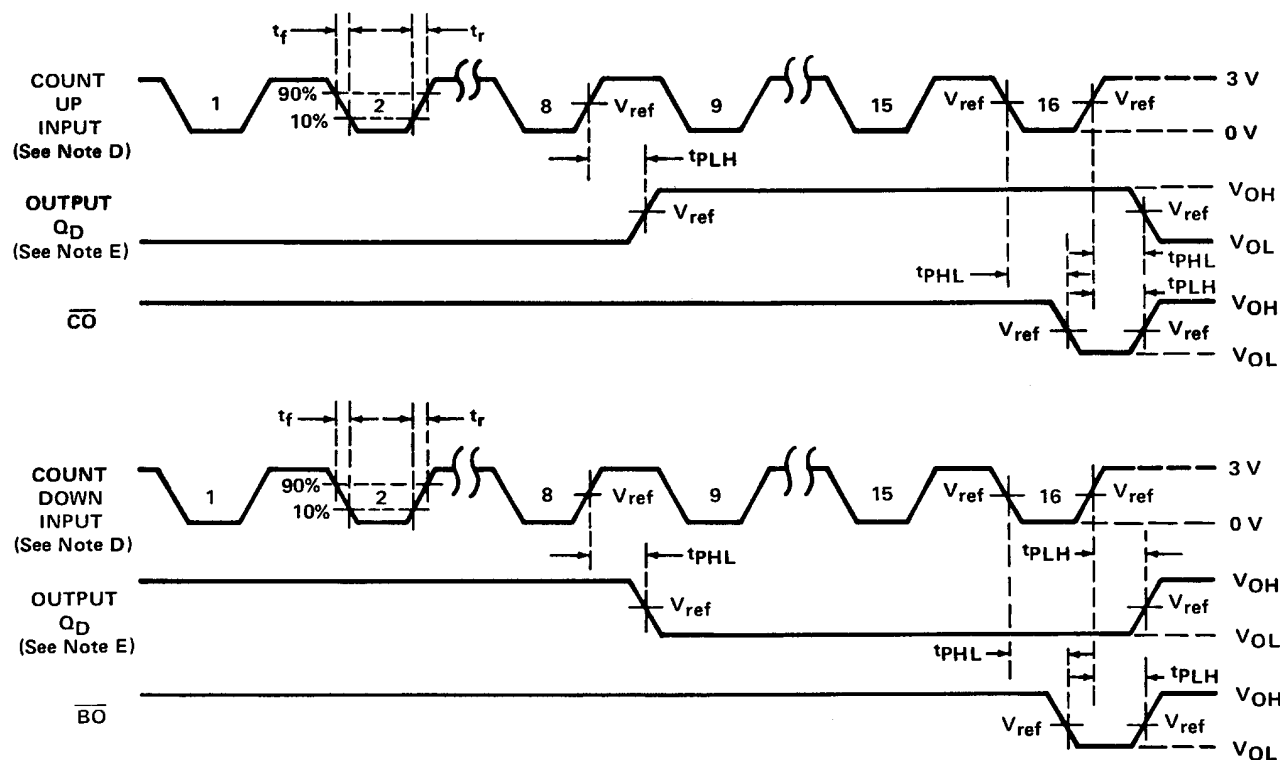
- NOTES: A. The pulse generators have the following characteristics: PRR $\approx$ 1 MHz, $Z_{out} \approx 50 \Omega$, duty cycle = 50%.
 B. C_L includes probe and jig capacitance.
 C. Diodes are 1N3064 or equivalent.
 D. Count-up and count-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
 E. Waveforms for outputs Q_A , Q_B , and Q_C are omitted to simplify the drawing.
 F. t_r and $t_f \leq 7$ ns.
 G. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2A - PROPAGATION DELAY TIMES

**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)**

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PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

- NOTES: A. The pulse generators have the following characteristics: PRR $\approx$ 1 MHz, $Z_{out} \approx 50 \Omega$, duty cycle = 50%.
B. C_L includes probe and jig capacitance.
C. Diodes are 1N3064 or equivalent.
D. Count-up and count-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
E. Waveforms for outputs Q_A , Q_B , and Q_C are omitted to simplify the drawing.
F. t_r and $t_f \leq 7$ ns.
G. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2B - PROPAGATION DELAY TIMES

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
5962-9558401QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Call TI	
5962-9558401QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Call TI	
5962-9558401QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Call TI	
76006012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Call TI	
76006012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Call TI	
7600601EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Call TI	
7600601EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Call TI	
7600601FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Call TI	
7600601FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Call TI	
JM38510/01309BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
JM38510/01309BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
JM38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
JM38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
JM38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
JM38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
JM38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
JM38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
JM38510/31508SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	
JM38510/31508SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	
JM38510/31508SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	
JM38510/31508SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	
M38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
M38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
M38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
M38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
M38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
M38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
M38510/31508SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	
M38510/31508SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	
M38510/31508SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
M38510/31508SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	
SN54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SN54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SN54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
SN54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
SN54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SN54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SN74192N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74192N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74193N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74193N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74193N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74193N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74LS192D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	
SN74LS192D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	
SN74LS192N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74LS192N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74LS193D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN74LS193DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
SN74LS193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
SN74LS193N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS193N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS193N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74LS193N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	
SN74LS193NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS193NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS193NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS193NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SNJ54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SNJ54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SNJ54192W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
SNJ54192W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
SNJ54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	
SNJ54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SNJ54193W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	
SNJ54193W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	
SNJ54LS193FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
SNJ54LS193FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
SNJ54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SNJ54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	
SNJ54LS193W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	
SNJ54LS193W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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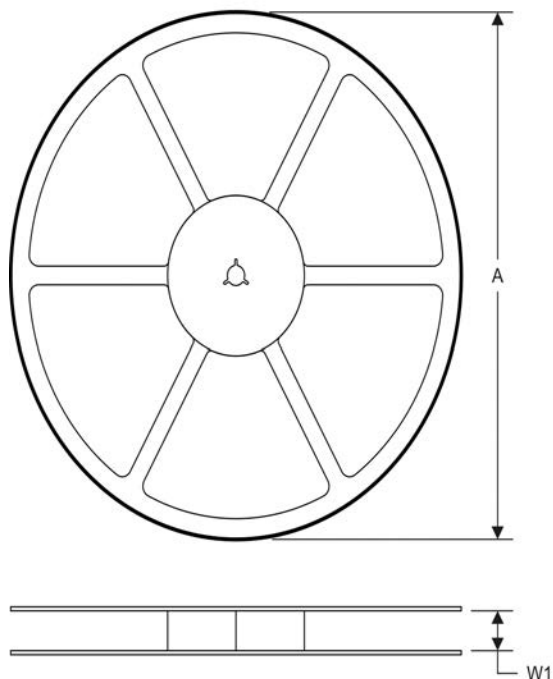
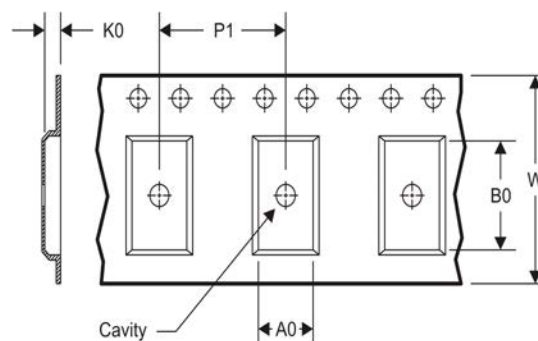
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OTHER QUALIFIED VERSIONS OF SN54192, SN54193, SN54LS193, SN54LS193-SP, SN74192, SN74193, SN74LS193 :

- Catalog: [SN74192](#), [SN74193](#), [SN74LS193](#), [SN54LS193](#)
- Military: [SN54192](#), [SN54193](#), [SN54LS193](#)
- Space: [SN54LS193-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS193DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS193NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



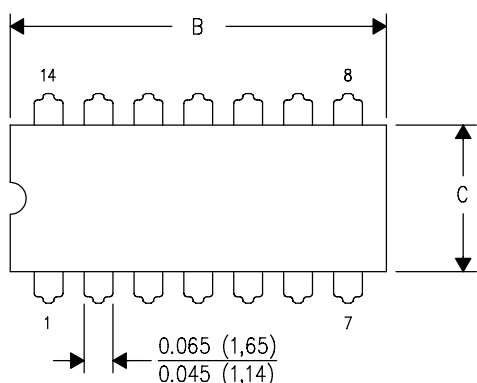
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS193DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS193NSR	SO	NS	16	2000	346.0	346.0	33.0

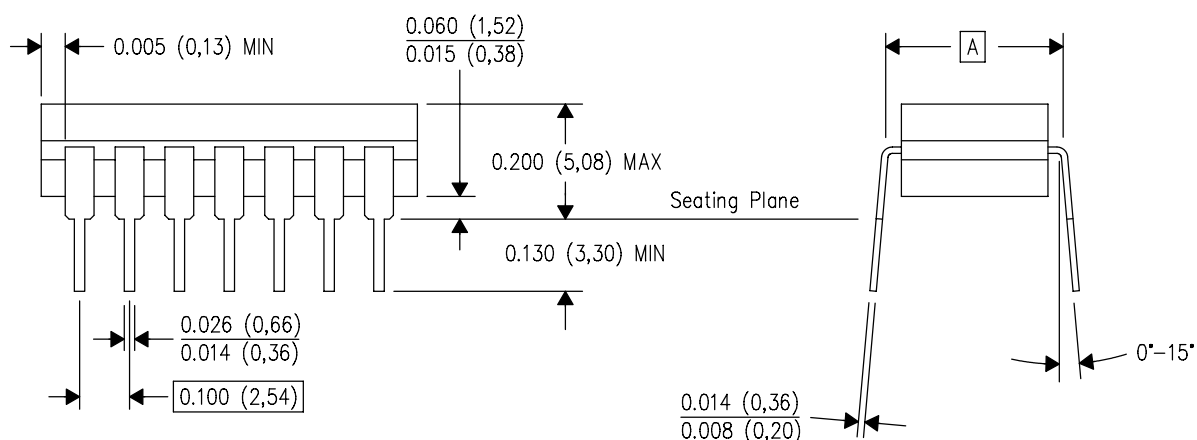
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

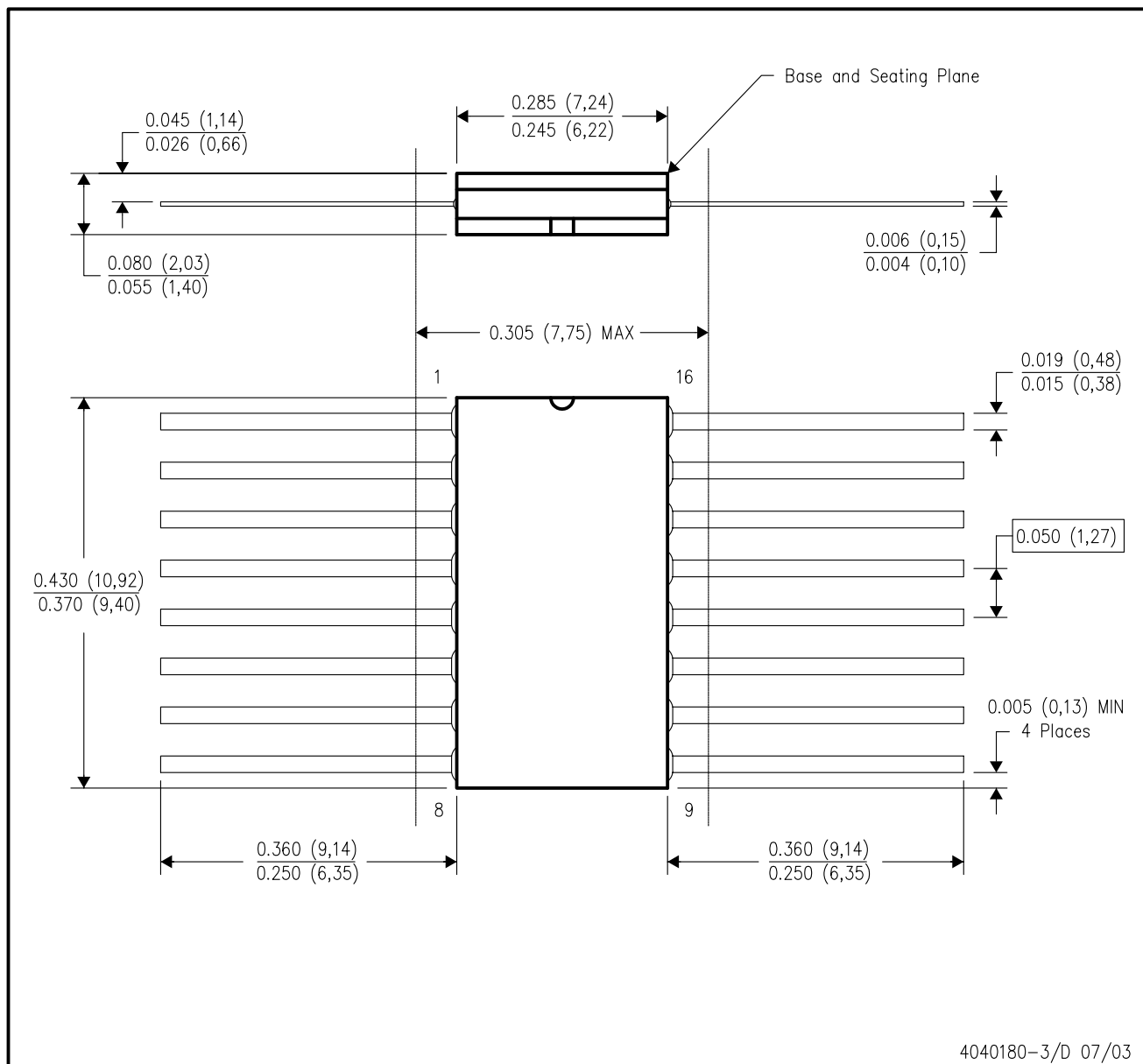


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK

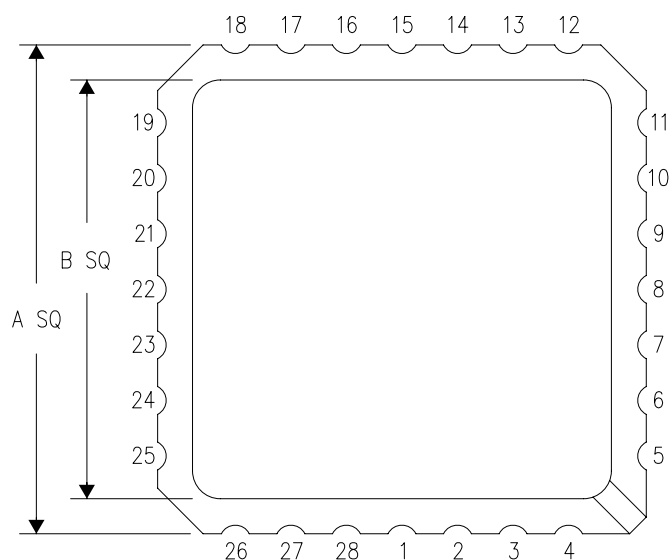


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

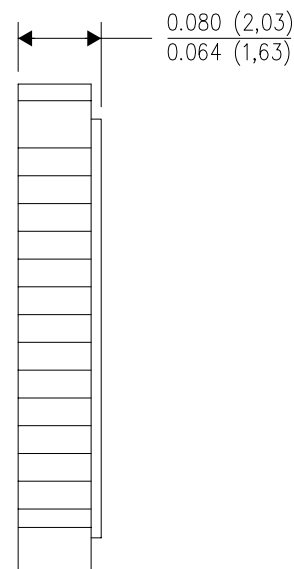
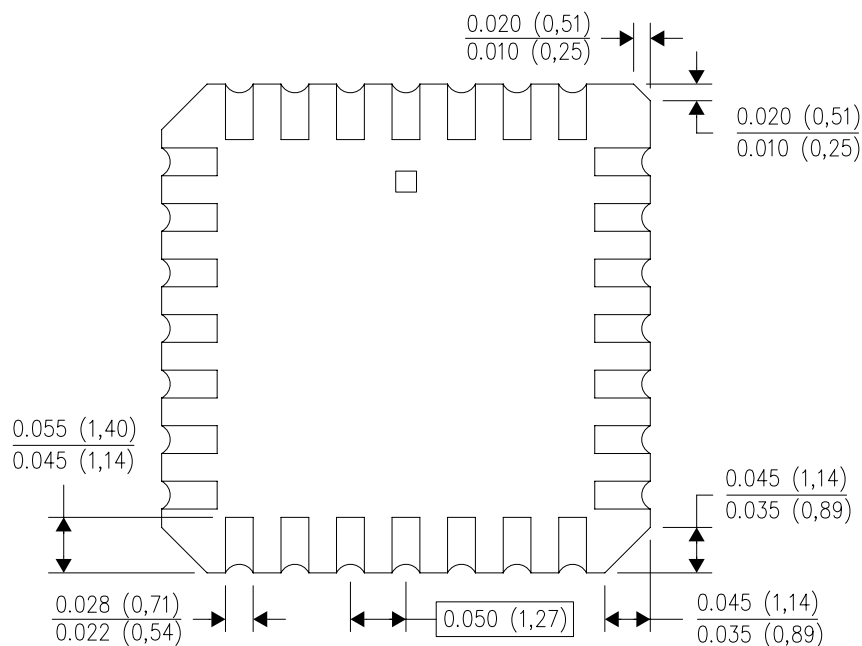
FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



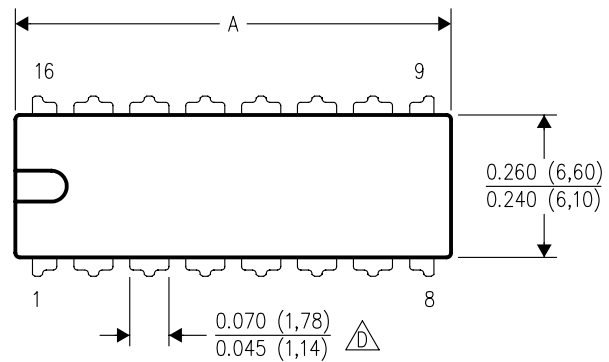
4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

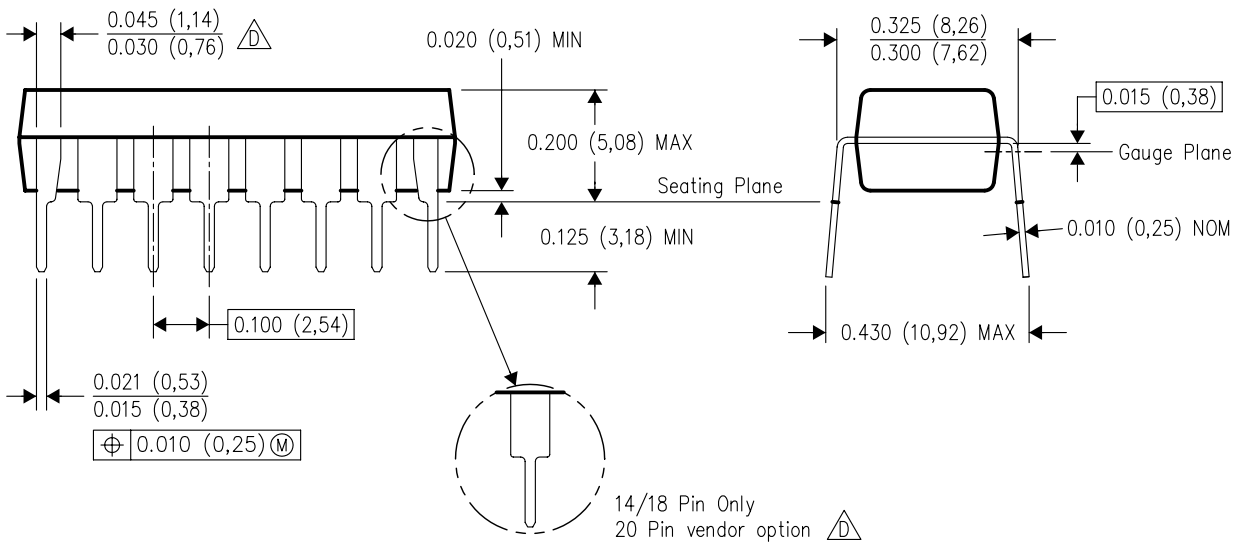
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD

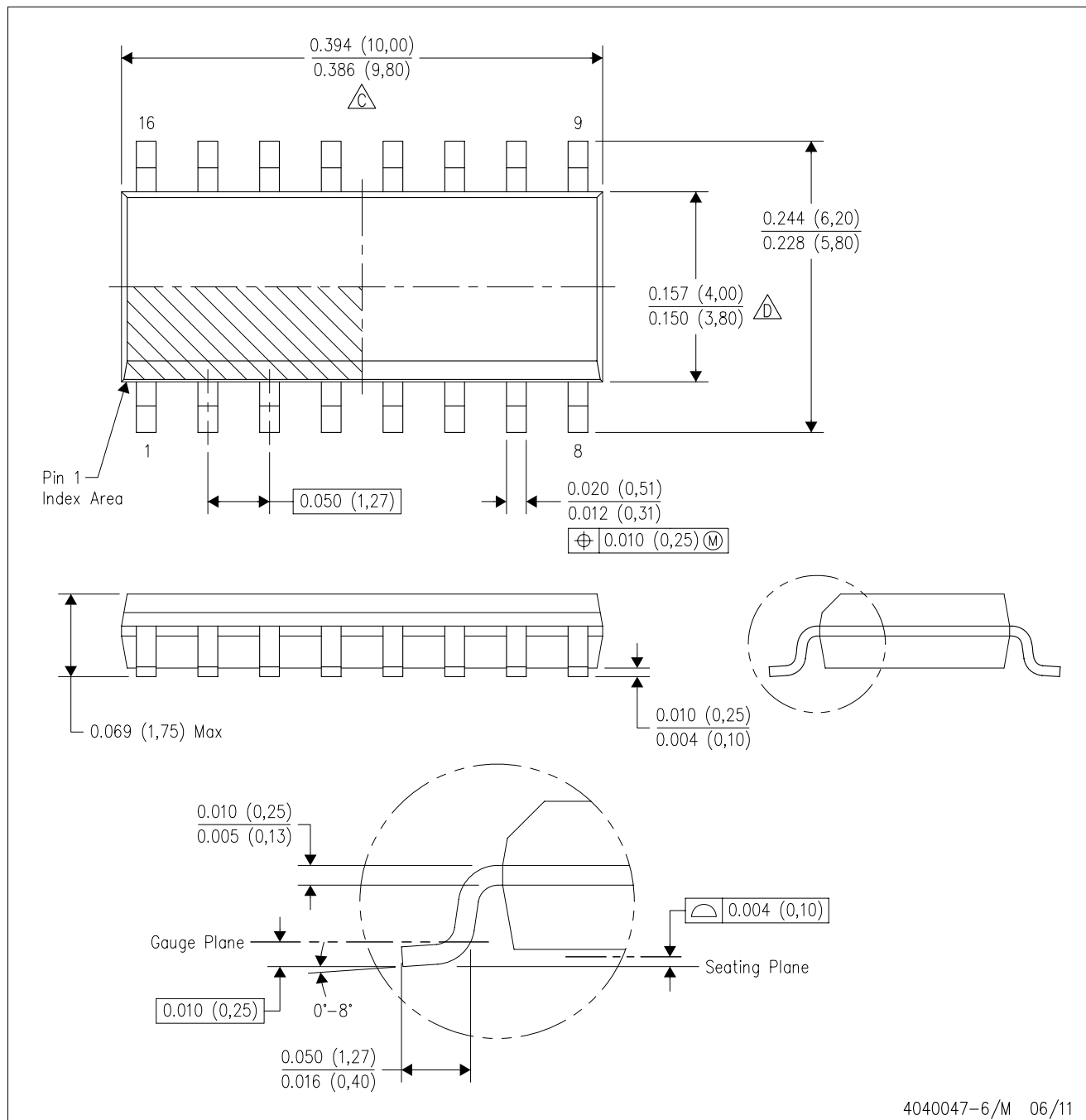


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

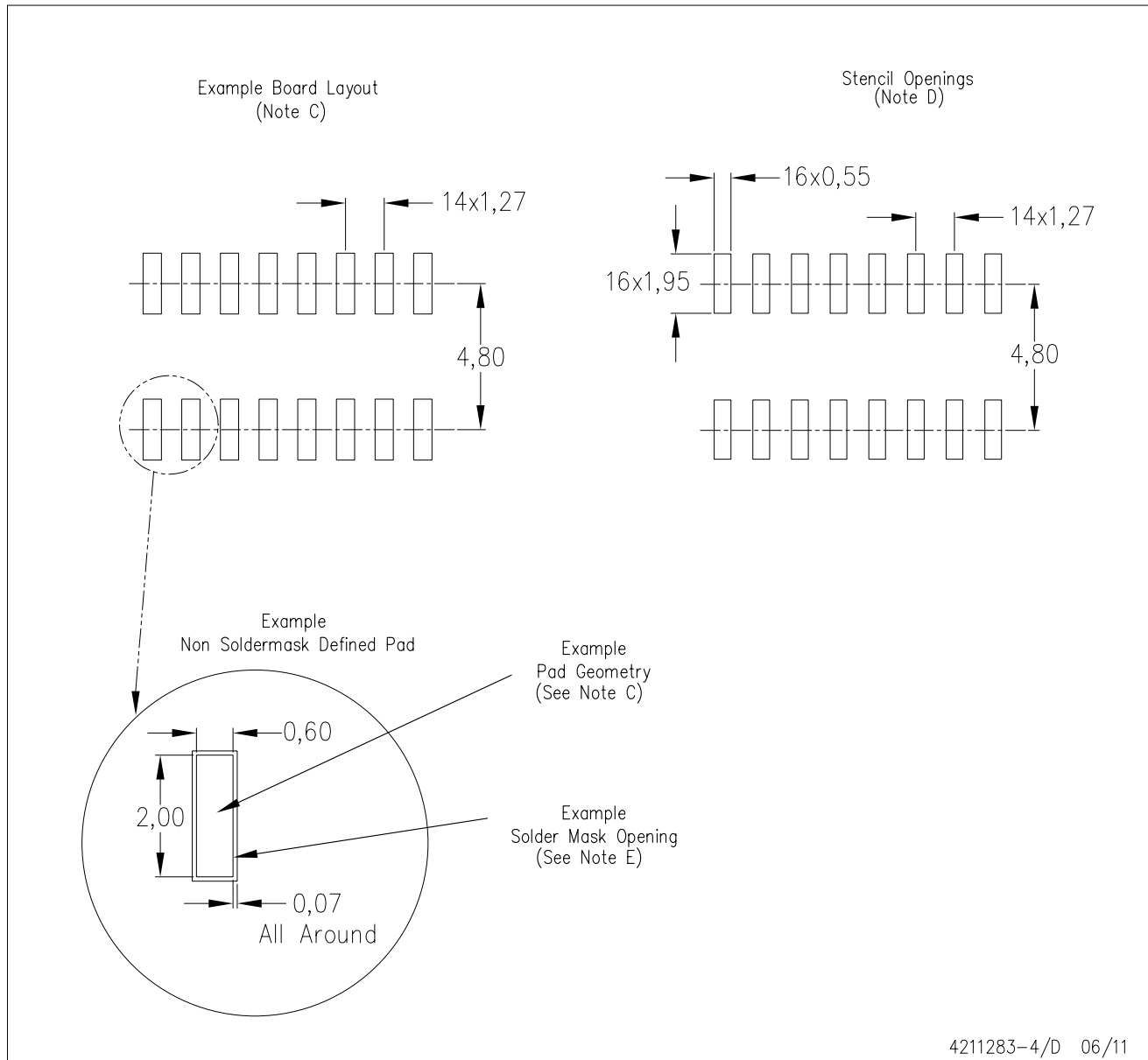


4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



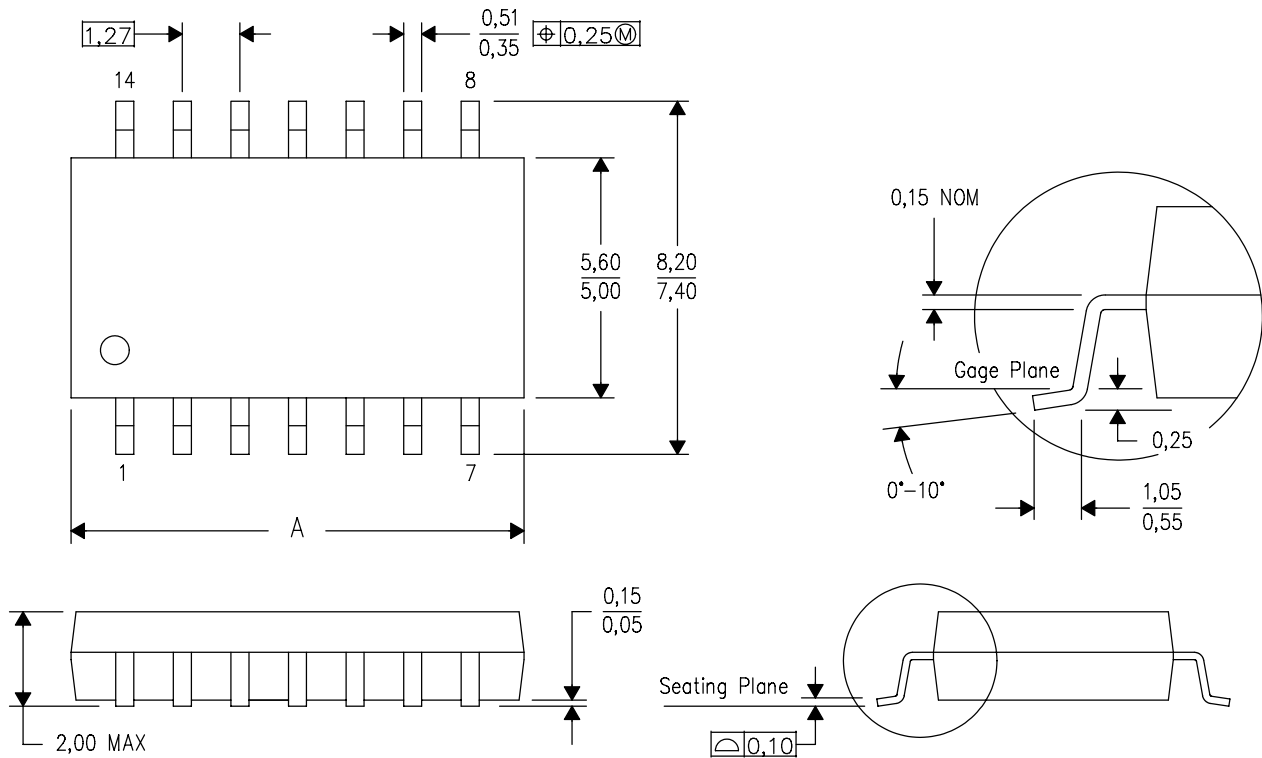
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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